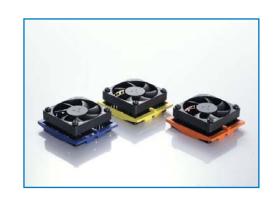


HI-TEMP FAN HEAT SINK - FEX Series

High Operating Temperature Integrated Fan Heat Sinks

DESIGN FEATURES

- Industry-leading maximum operating temperature of 90°C
- Compatible with 35x35 mm and 40x40 mm chipset footprints
- Common 5VDC @ 0.5 A (max) USB 2.0 fan electrical specifications
- Extruded crosscut fins heat sink



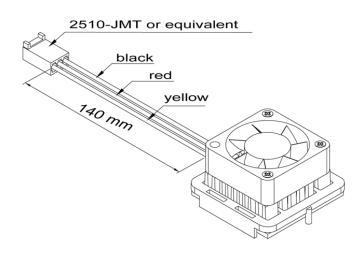
DESCRIPTION

The **FEX** series for integrated-fan heat sinks is uniquely designed to absorb and disperse heat away from high temperature devices while offering key features such as an operating temperature range of -10°C to 90°C, calculated MTTF @ 90°C: 86,858 hours (GEM, 90% confidence) and low profile to fit applications with space constraints.

CTS' series of hi-temp fansinks maintain superior thermal dissipation for devices that emit high amount of heat. Our fansinks are available a wide range of footprints and fin heights which make them suitable for many elevated temperature applications such as component testing, burn-in, high density servers, high-speed computing and video, and use in areas where the system airflow is constrained.

Part Number	Length x Width x Height (mm)	Thermal Resistance (R _™)
FEX35-35-21	35 x 35 x 21.0 +/- 0.5	
FEX35-35-21/M2	39.2 x 37.2 x 21.0 +/- 0.5 (with clip)	1.92
FEX40-40-21	40 x 40 x 21.2 +/- 0.5	
FED40-40-21/M2	44.2 x 42.7 x 21.2 +/- 0.5 (with clip)	1.79

PACKAGE

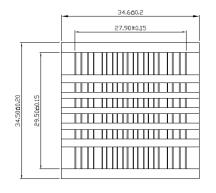


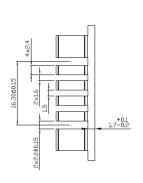


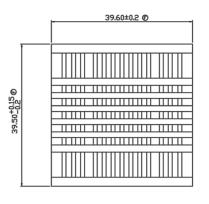


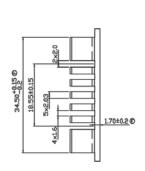
FEX 35-35-21

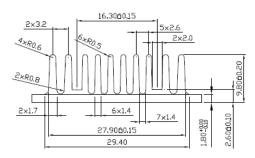
FEX40-40-21

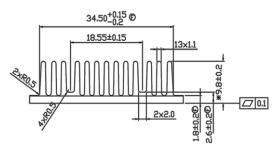












ORDERING INFORMATION

